

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants	: Masaru SHIRAI et al.	Group Art Unit : 1793
Appl. No.	: 10/598,142	Examiner : Nicholas P D'ANIELLO
Filed	: August 18, 2006	Confirmation No. : 1550
For	: HEATER, REFLOW APPARATUS, AND SOLDER BUMP FORMING METHOD AND APPARATUS	

AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop **Amendment**
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

This is in response to the Office Action mailed April 20, 2009. Inasmuch as the three-month shortened statutory period is originally set in the Office Action to expire on July 20, 2009, this paper is filed timely. However, if the Office deems an Extension of Time necessary, the same is hereby requested, and the undersigned authorizes the Office to charge any requisite fee due for consideration of this Response to Deposit Account No. 19-0089.

Applicants respectfully request reconsideration and withdrawal of the rejections in view of the amendments and remarks which follow:

Amendments to the Claims are reflected in the Listing of Claims, beginning on page 2 of this paper.

Remarks begin on page 8 of this paper.